NOVEL MATERIALS AND INNOVATIVE SEMICONDUCTORS

NCD3T400MP330S

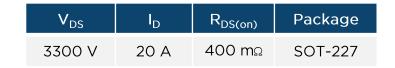
3300 V Silicon Carbide Bi-Directional MOSFET (CD-BiFET)

Features

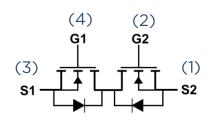
- State-of-the-art SiC MOSFET technology
- Reliable gate oxide process
- 100% avalanche tested
- Dual gate control
- · Electrically isolated baseplate

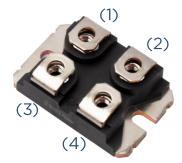
Benefits

- Higher system efficiency
- Reduced cooling requirements
- Increased power density
- Increased system switching frequency
- · Enhanced system reliability
- Reduced total harmonic distortion



COMING SOON - 200 mΩ CD-BiFET





Applications

- Solid-state circuit breakers
- Matrix (AC/AC) converters
- Current source converters
- Energy storage systems
- Solid-state power controllers
- Uninterruptible power supplies

Electrical Characteristics

Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	Note
Drain-Source Voltage	V _{(BR)S2S1}	T _C = 25 °C	3300	-	-	>	
Zero Gate Voltage Drain Current	I _{S2S1}	V _{S2S1} = 3300 V, V _{G1S1} = 0 V	-	1	100	μА	
Gate-Source Voltage	V _{GS(max)}		-10	1	25	· v	
	$V_{\rm GS,op}$	Recommended Operation	-	-5/+20	-		
Gate Threshold Voltage	V _{G1S1(th)}	$V_{G1S1} = V_{S2S1}$, $V_{G1S1} = 20$ V, $I_{S2} = 2.5$ mA	2	2.64	3	٧	Fig. 4
Drain-Source On-State Resistance	R _{S2S1(on)}	T _C = 25 °C	-	400	ı	mΩ	Fig. 1
Continuous Drain Current	I _S	V _{G1S1} = 20 V, T _C = 25 °C	-	20	-	Α	
Turn-On Switching Energy	E _{ON}	V_{S2} = 2000 V, I_{S2} = 15 A, V_{G1S1} = -5 / +20 V, $R_{G(ext)}$ = 10 Ω , L = 1.7 mH	-	1550	-	μJ	
Turn-Off Switching Energy	E _{OFF}		-	155	1		Fig. 3
Total Switching Energy	E _{TOT}		-	1705	-		

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Typical Performance

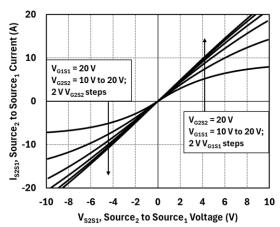
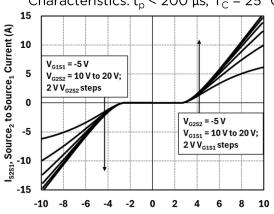


Figure 1: Forward and Reverse Output Characteristics: $t_p < 200 \mu s$, $T_C = 25 ^{\circ}C$



 v_{s2s1} , Source₂ to Source₁ Voltage (V) Figure 3: Forward and Reverse Output Characteristics: $t_{\rm p} < 200~\mu s$, $T_{\rm C} = 25~{\rm ^{\circ}C}$

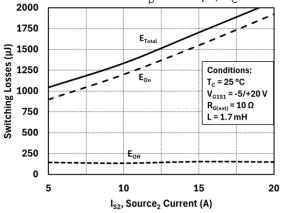


Figure 5: Switching Energy vs. Drain Current

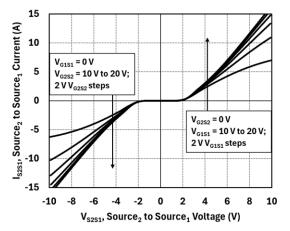


Figure 2: Forward and Reverse Output Characteristics: $t_p < 200 \mu s$, $T_C = 25 ^{\circ}C$

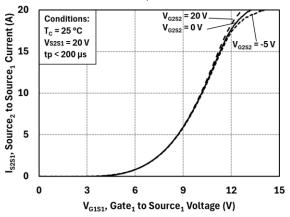


Figure 4: Transfer Characteristics

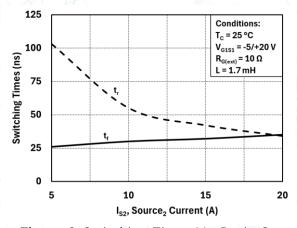


Figure 6: Switching Times Vs. Drain Current

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